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April 1<sup>st</sup>, 2010 Renesas Electronics Corporation

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# MOS FIELD EFFECT TRANSISTOR NP36P04KDG

### SWITCHING P-CHANNEL POWER MOSFET

#### DESCRIPTION

The NP36P04KDG is P-channel MOS Field Effect Transistor designed for high current switching applications.

#### <R> ORDERING INFORMATION

PART NUMBER	LEAD PLATING	PACKING	PACKAGE	
NP36P04KDG-E1-AY Note				
NP36P04KDG-E2-AY Note	Pure Sn (Tin)	Tape 800 p/reel	TO-263 (MP-25ZK)	

Note Pb-free (This product does not contain Pb in external electrode.)

#### FEATURES

Super low on-state resistance

 $R_{DS(on)1}$  = 17.0 m $\Omega$  MAX. (VGs = -10 V, ID = -18 A)

 $R_{DS(on)2}$  = 23.5 m $\Omega$  MAX. (V<sub>GS</sub> = -4.5 V, I<sub>D</sub> = -18 A)

- Low input capacitance
- Ciss = 2800 pF TYP.

#### ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Drain to Source Voltage (V <sub>GS</sub> = 0 V)	VDSS	-40	V
Gate to Source Voltage (VDs = 0 V)	Vgss	∓20	V
Drain Current (DC) (Tc = 25°C)	D(DC)	∓36	А
Drain Current (pulse) <sup>Note1</sup>	D(pulse)	<b>∓108</b>	А
Total Power Dissipation (Tc = $25^{\circ}$ C)	Ρτ1	56	W
Total Power Dissipation (T <sub>A</sub> = 25°C)	Pt2	1.8	W
Channel Temperature	Tch	175	°C
Storage Temperature	Tstg	-55 to +175	°C
Single Avalanche Current Note2	las	26	А
Single Avalanche Energy <sup>Note2</sup>	Eas	72	mJ

**Notes 1.** PW  $\leq$  10  $\mu$ s, Duty Cycle  $\leq$  1%

**2.** Starting T<sub>ch</sub> = 25°C, V<sub>DD</sub> = -30 V, R<sub>G</sub> = 25  $\Omega$ , V<sub>GS</sub> =  $-20 \rightarrow 0$  V

#### THERMAL RESISTANCE

Channel to Case Thermal Resistance	Rth(ch-C)	2.68	°C/W
Channel to Ambient Thermal Resistance	Rth(ch-A)	83.3	°C/W

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Document No. D18686EJ3V0DS00 (3rd edition) Date Published May 2007 NS CP(K) Printed in Japan

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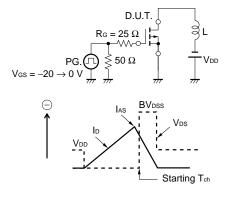
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	loss	V <sub>DS</sub> = -40 V, V <sub>GS</sub> = 0 V			-10	μA
Gate Leakage Current	Igss	V <sub>GS</sub> = ∓20 V, V <sub>DS</sub> = 0 V			∓100	nA
Gate to Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = -10 V, I <sub>D</sub> = -1 mA	-1.0	-1.6	-2.5	V
Forward Transfer Admittance Note	y <sub>fs</sub>	V <sub>DS</sub> = -10 V, I <sub>D</sub> = -18 A	12	22		S
Drain to Source On-state Resistance Note	RDS(on)1	V <sub>GS</sub> = −10 V, I <sub>D</sub> = −18 A		12.8	17.0	mΩ
	RDS(on)2	V <sub>GS</sub> = -4.5 V, I <sub>D</sub> = -18 A		16.6	23.5	mΩ
Input Capacitance	Ciss	V <sub>DS</sub> = -10 V,		2800		pF
Output Capacitance	Coss	V <sub>GS</sub> = 0 V,		450		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		280		pF
Turn-on Delay Time	t <sub>d(on)</sub>	$V_{DD}$ = -20 V, I <sub>D</sub> = -18 A,		8		ns
Rise Time	tr	V <sub>GS</sub> = -10 V,		10		ns
Turn-off Delay Time	t <sub>d(off)</sub>	R <sub>G</sub> = 0 Ω		250		ns
Fall Time	tr			140		ns
Total Gate Charge	QG	$V_{DD} = -32 V,$		55		nC
Gate to Source Charge	Q <sub>GS</sub>	V <sub>GS</sub> = -10 V,		7		nC
Gate to Drain Charge	Qgd	I⊳ = −36 A		15		nC
Body Diode Forward Voltage Note	V <sub>F(S-D)</sub>	IF = -36 A, V <sub>GS</sub> = 0 V		0.95	1.5	V
Reverse Recovery Time	trr	IF = -36 A, V <sub>GS</sub> = 0 V,		44		ns
Reverse Recovery Charge	Qrr	di/dt = -100 A/µs		51		nC

#### ELECTRICAL CHARACTERISTICS (TA = 25°C)

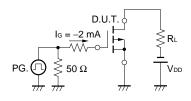
**Note** Pulsed test PW  $\leq$  350  $\mu$ s, Duty Cycle  $\leq$  2%

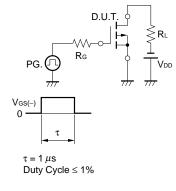
#### TEST CIRCUIT 1 AVALANCHE CAPABILITY

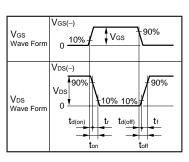
#### **TEST CIRCUIT 2 SWITCHING TIME**



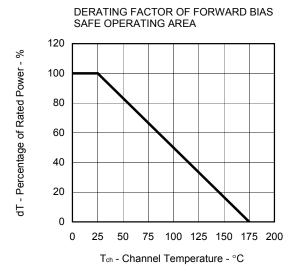
#### **TEST CIRCUIT 3 GATE CHARGE**



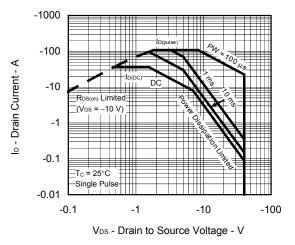


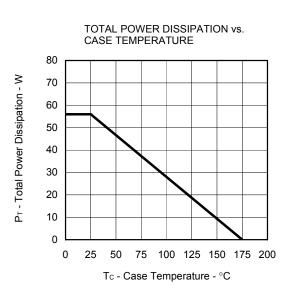


#### TYPICAL CHARACTERISTICS (TA = 25°C)

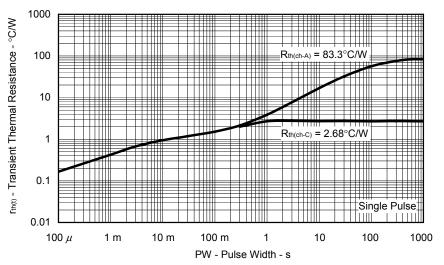




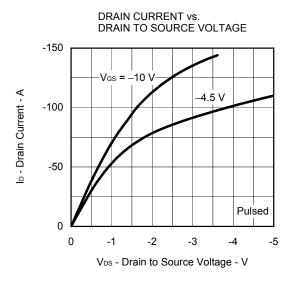




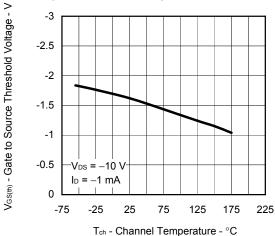
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

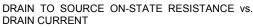




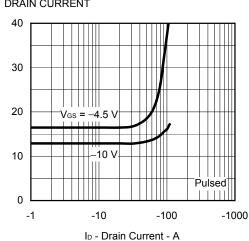




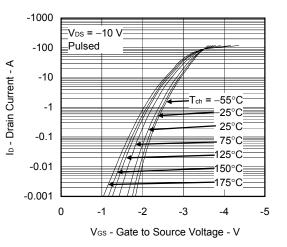




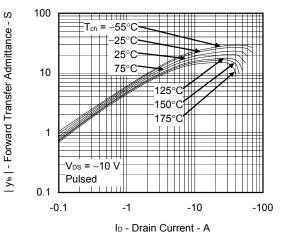




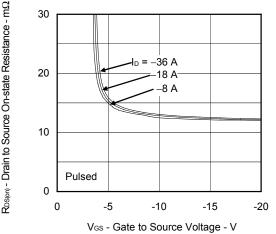
FORWARD TRANSFER CHARACTERISTICS

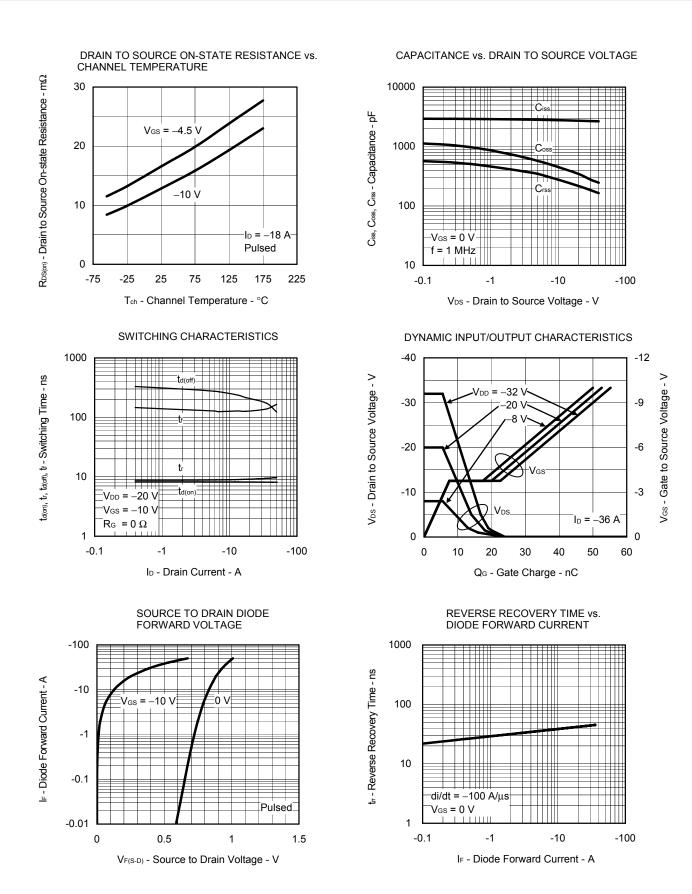


FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT

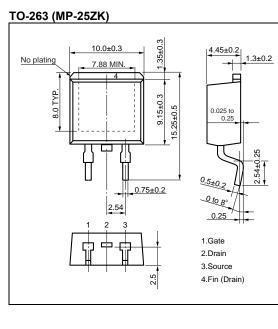


DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

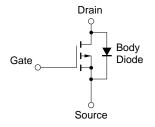




#### PACKAGE DRAWING (Unit: mm)



#### EQUIVALENT CIRCUIT



**Remark** Strong electric field, when exposed to this device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred.

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